

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2817747

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	Hsilin Huang	04/11/2014
RECEIVING PARTY DATA		
Name:	MediaTek Singapore Pte. Ltd.	
Street Address:	No. 1 Fusionopolis Walk, #03-01 Solaris	
City:	Singapore	
State/Country:	SINGAPORE	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14254898
CORRESPONDENCE DATA		
Fax Number:	(703)997-4517	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	3027291562	
Email:	Patent.admin.uspto.cr@naipo.com	
Correspondent Name:	WINSTON HSU	
Address Line 1:	P.O.BOX 506	
Address Line 4:	MERRIFIELD, VIRGINIA 22116	
ATTORNEY DOCKET NUMBER:	MSLP0263USA	
NAME OF SUBMITTER:	SHELLEY KUO	
SIGNATURE:	/SHELLEY KUO/	
DATE SIGNED:	04/17/2014	
Total Attachments: 2		
source=1926916#page1.tif		
source=1926916#page2.tif		

PATENT

Docket No. MSLP0263USA

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Hsilin Huang Nationality: US

Hereby sells, assigns and transfers to:

ASSIGNEE(S):

Name: MediaTek Singapore Pte. Ltd.

Address: No. 1 Fusionopolis Walk, #03-01 Solaris, Singapore 138628, Singapore

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"MULTI-HIERARCHY INTERCONNECT SYSTEM AND METHOD FOR CACHE SYSTEM"

Which is found in:

- (a) + U.S. patent application executed on even date
- (b) _____ U.S. patent application executed on _____
- (c) _____ U.S. application serial no. _____
- (d) _____ patent no. _____ issued _____
- (e) _____ International application no. _____

NPO#MSL-P0263-USA:0
CUST#MUSI-13-006US

Assignment, Page 1 of 2

F#NPO-P0002E-USI
DSC0-103U002430

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment:

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this APR 11 2014 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Hsilin Huang

Signature of INVENTOR

